

OSRAM KW CELMM2.TK

Datasheet

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Tobelbader Strasse 30, 8141 Premstaetten, Austria

Phone +43 3136 500-0

ams-osram.com

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OSLON® Boost HM

KW CELMM2.TK

OSLON® Boost HM utilizes the high current capability of the latest chip generation in a special package for good thermal behaviour. The LED is characterized by a high luminance of up to 275 cd / mm² and a high luminous flux. Therefore this LED is ideally suited as a powerful light source for ultra-slim headlamp designs.



Applications

- Dynamic Forward Lighting
- Static Forward Lighting

Features

- Package: Ceramic package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.3104, Cy = 0.3162 acc. to CIE 1931 (• white)
- Corrosion Robustness Class: 3A
- Qualifications: AEC-Q102 Qualified with RV-level 1
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

Ordering Information

Type	Luminous Flux ¹⁾ $I_F = 1200\text{ mA}$ Φ_V	Ordering Code
KW CELMM2.TK-S2S8-4L16M1	355 ... 510 lm	Q65113A5393
KW CELMM2.TK-S2S8-4L25M2	355 ... 510 lm	Q65113A5394
KW CELMM2.TK-S2S8-4L35M3	355 ... 510 lm	Q65113A5398

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature ²⁾	T_{op}	min.	-40 °C
		max.	135 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	135 °C
Junction Temperature	T_j	max.	150 °C
Junction Temperature for short time applications*	T_j	max.	175 °C
Forward current $T_s = 25\text{ °C}$	I_F	min.	50 mA
		max.	1300 mA
Forward current pulsed $D = 0.005$; $T_s = 25\text{ °C}$	$I_{F\text{ pulse}}$	max.	2000 mA
Surge current $t \leq 10\text{ }\mu\text{s}$; $D = 0.005$; $T_s = 25\text{ °C}$	I_{FS}	max.	2500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V_{ESD}		8 kV
Reverse current ³⁾	I_R	max.	200 mA

* The median lifetime (L70/B50) for $T_j = 175\text{ °C}$ is 100h.

Characteristics

$I_F = 1200 \text{ mA}$; $T_S = 25 \text{ °C}$

Parameter	Symbol		Values
Chromaticity Coordinate ⁴⁾	C _x	typ.	0.3104
	C _y	typ.	0.3162
Viewing angle at 50% I_V	2 ϕ	typ.	120 °
Forward Voltage ⁵⁾ $I_F = 1200 \text{ mA}$	V_F	min.	3.00 V
		typ.	3.40 V
		max.	3.75 V
Reverse voltage (ESD device)	$V_{R \text{ ESD}}$	min.	45 V
Reverse voltage ³⁾ $I_R = 20 \text{ mA}$	V_R	max.	1.2 V
Real thermal resistance junction/solderpoint ⁶⁾	$R_{\text{thJS real}}$	typ.	6.7 K / W
		max.	8.1 K / W
Electrical thermal resistance junction/solderpoint ⁶⁾ with efficiency $\eta_e = 32 \text{ %}$	$R_{\text{thJS elec.}}$	typ.	4.6 K / W
		max.	5.5 K / W

The R_{th} of the LED is valid on an exposed copper MC-PCB.

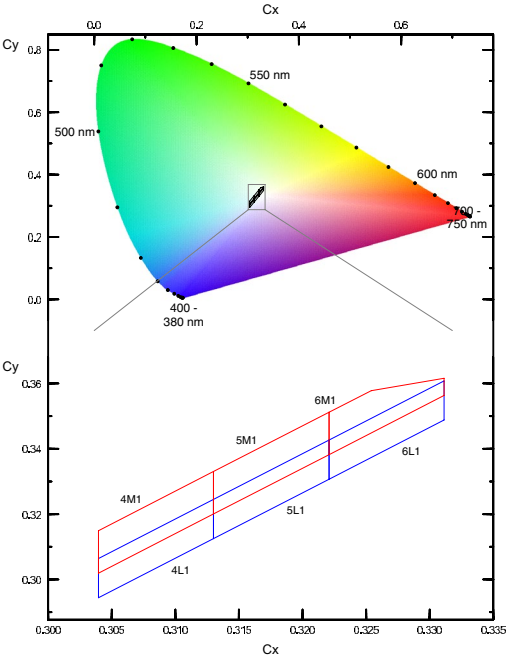
Brightness Groups

Group	Luminous Flux ¹⁾ $I_F = 1200 \text{ mA}$ min. Φ_V	Luminous Flux ¹⁾ $I_F = 1200 \text{ mA}$ max. Φ_V
S2	355 lm	375 lm
S3	375 lm	395 lm
S4	395 lm	415 lm
S5	415 lm	435 lm
S6	435 lm	460 lm
S7	460 lm	485 lm
S8	485 lm	510 lm

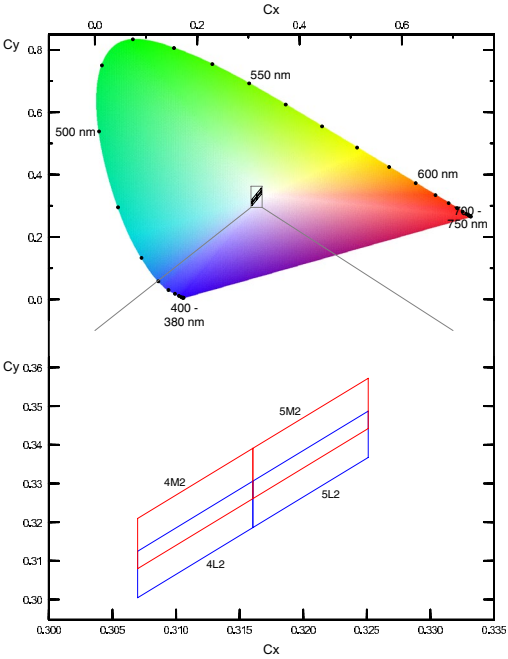
Forward Voltage Groups

Group	Forward Voltage ⁵⁾ $I_F = 1200 \text{ mA}$ min. V_F	Forward Voltage ⁵⁾ $I_F = 1200 \text{ mA}$ max. V_F
0	3.00 V	3.75 V

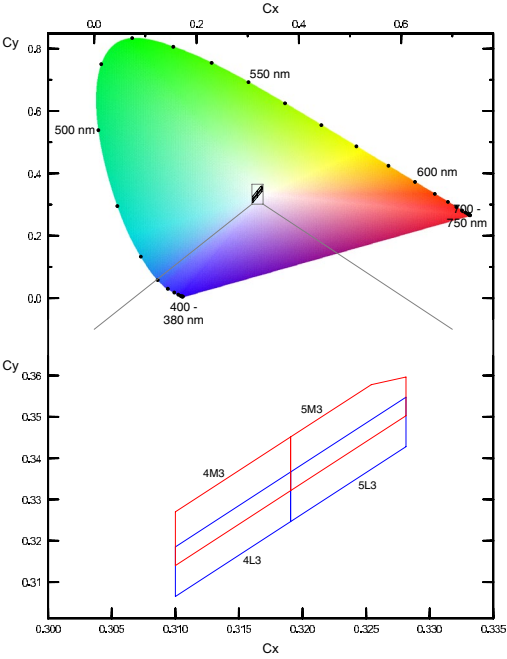
Chromaticity Coordinate Groups



Chromaticity Coordinate Groups



Chromaticity Coordinate Groups



Chromaticity Coordinate Groups ⁴⁾

Group	Cx	Cy	Group	Cx	Cy	Group	Cx	Cy
4L1	0.3040	0.2944	4M3	0.3100	0.3140	5M2	0.3160	0.3261
	0.3040	0.3064		0.3100	0.3270		0.3160	0.3391
	0.3130	0.3245		0.3191	0.3451		0.3251	0.3572
	0.3130	0.3125		0.3191	0.3321		0.3251	0.3442
4L2	0.3070	0.3005	5L1	0.3130	0.3125	5M3	0.3191	0.3321
	0.3070	0.3125		0.3130	0.3245		0.3191	0.3451
	0.3160	0.3306		0.3221	0.3427		0.3254	0.3578
	0.3160	0.3186		0.3221	0.3307		0.3281	0.3597
4L3	0.3100	0.3065	5L2	0.3160	0.3186	6L1	0.3221	0.3307
	0.3100	0.3185		0.3160	0.3306		0.3221	0.3427
	0.3191	0.3366		0.3251	0.3487		0.3311	0.3608
	0.3191	0.3246		0.3251	0.3367		0.3311	0.3488
4M1	0.3040	0.3019	5L3	0.3191	0.3246	6M1	0.3221	0.3382
	0.3040	0.3149		0.3191	0.3366		0.3221	0.3512
	0.3130	0.3330		0.3281	0.3548		0.3254	0.3578
	0.3130	0.3200		0.3281	0.3428		0.3311	0.3616
4M2	0.3070	0.3080	5M1	0.3130	0.3200		0.3311	0.3563
	0.3070	0.3210		0.3130	0.3330			
	0.3160	0.3391		0.3221	0.3512			
	0.3160	0.3261		0.3221	0.3382			

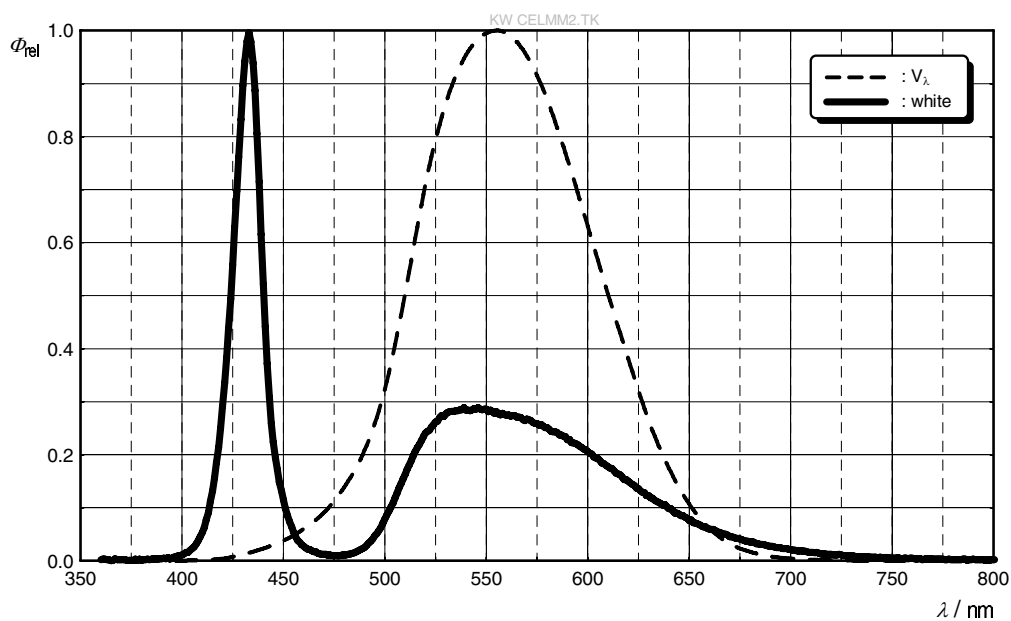
Group Name on Label

Example: S2-4L1

Brightness	Color Chromaticity
S2	4L1

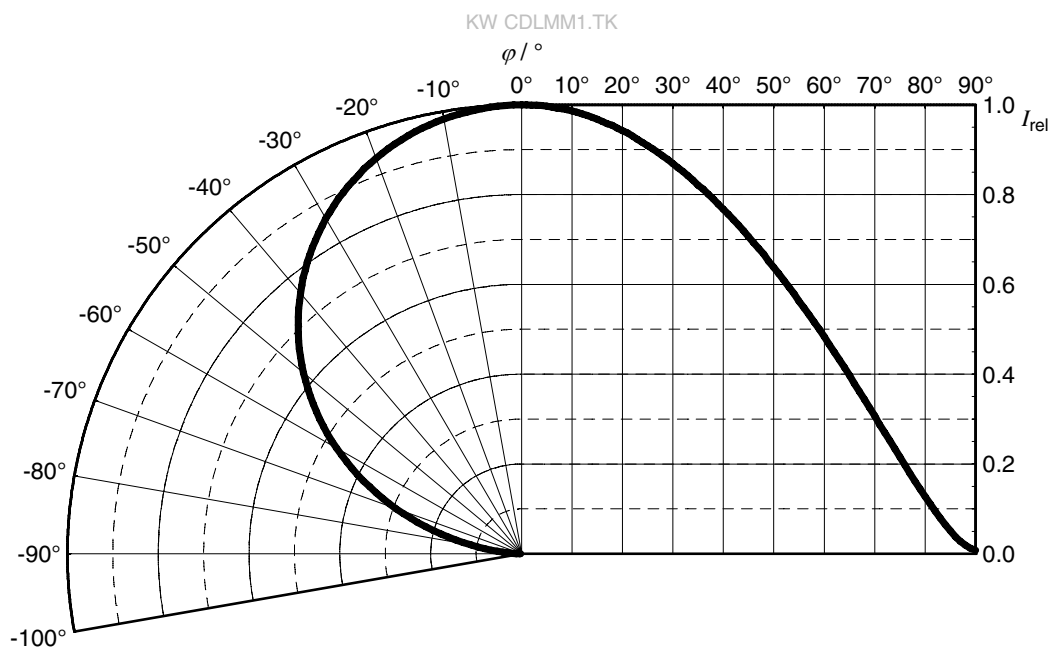
Relative Spectral Emission ⁷⁾

$\Phi_{\text{rel}} = f(\lambda)$; $I_F = 1200 \text{ mA}$; $T_J = 25 \text{ }^\circ\text{C}$



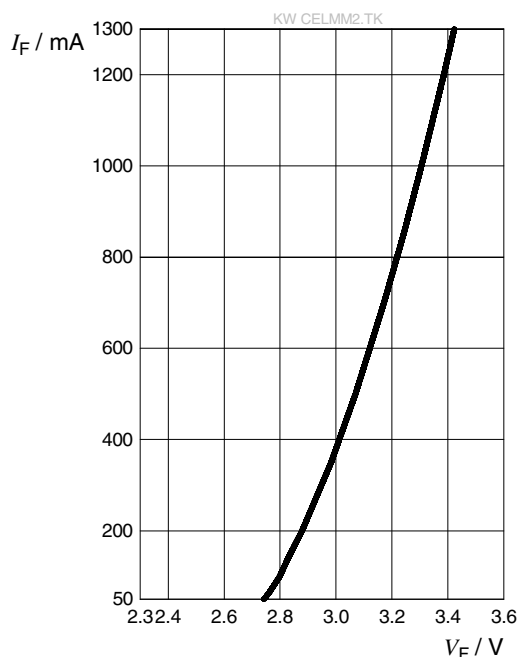
Radiation Characteristics ⁷⁾

$I_{\text{rel}} = f(\phi)$; $T_J = 25 \text{ }^\circ\text{C}$

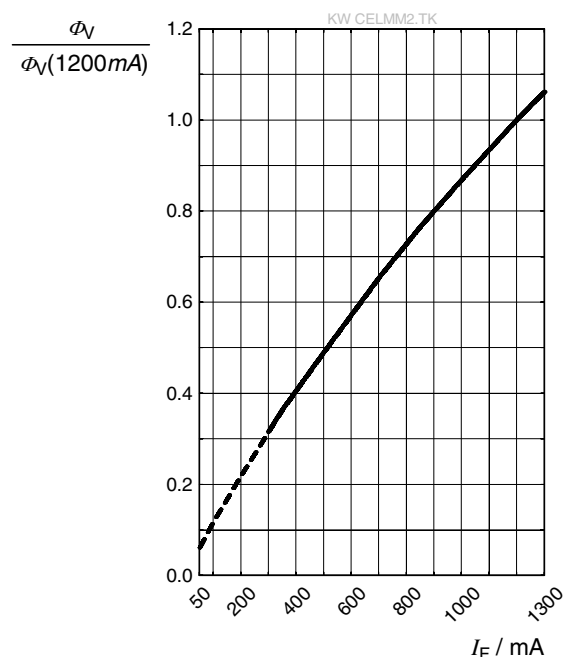


Forward current ⁷⁾

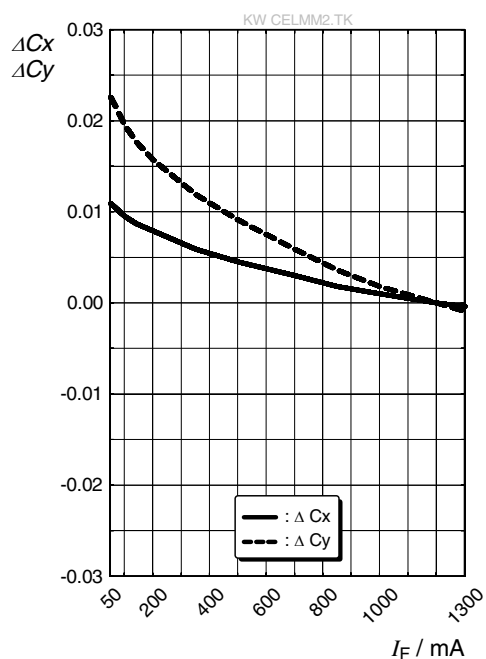
$$I_F = f(V_F); T_J = 25\text{ °C}$$

**Relative Luminous Flux** ^{7), 8)}

$$\Phi_V / \Phi_V(1200\text{ mA}) = f(I_F); T_J = 25\text{ °C}$$

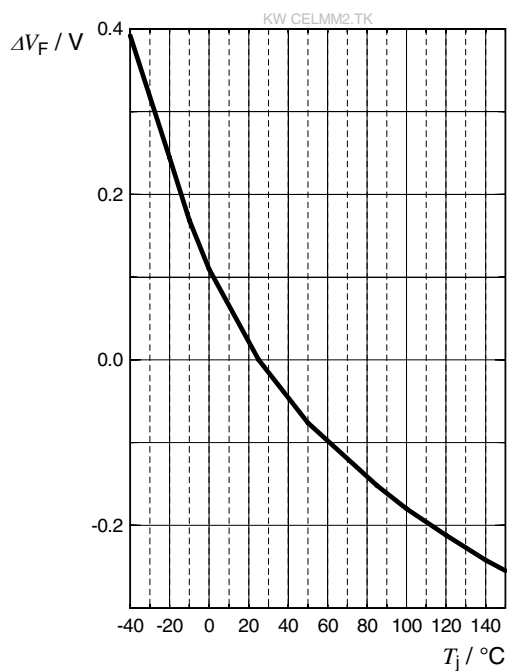
**Chromaticity Coordinate Shift** ⁷⁾

$$\Delta Cx, \Delta Cy = f(I_F); T_J = 25\text{ °C}$$

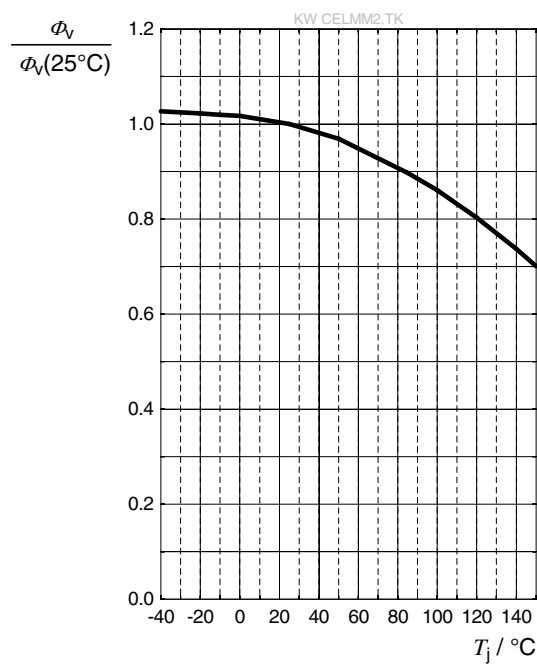


Forward Voltage ⁷⁾

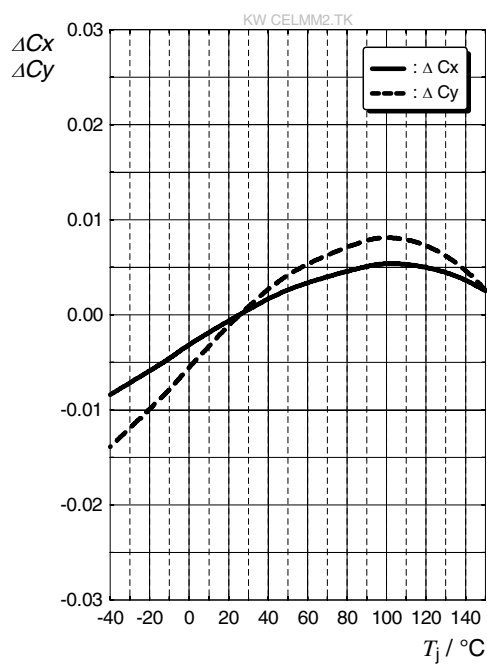
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 1200\text{ mA}$$

**Relative Luminous Flux** ⁷⁾

$$\Phi_V / \Phi_V(25^\circ\text{C}) = f(T_j); I_F = 1200\text{ mA}$$

**Chromaticity Coordinate Shift** ⁷⁾

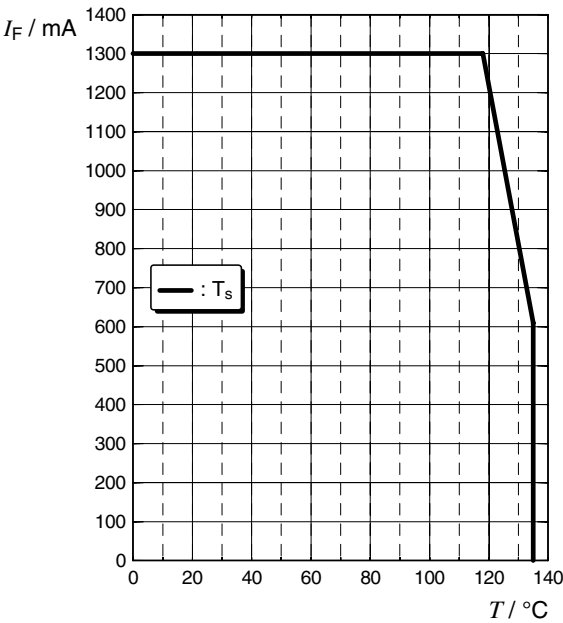
$$\Delta C_x, \Delta C_y = f(T_j); I_F = 1200\text{ mA}$$



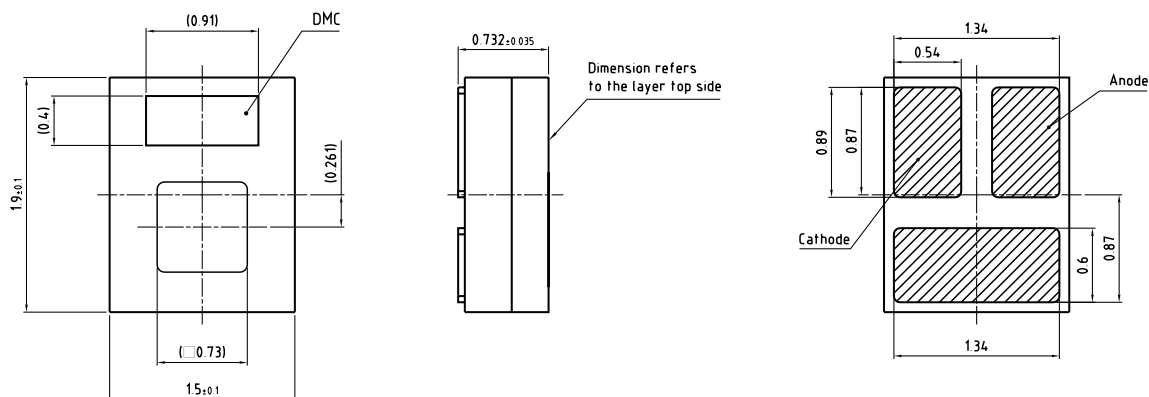
Max. Permissible Forward Current ⁶⁾

$I_F = f(T)$

KW CELMM2.TK



Dimensional Drawing ⁹⁾



general tolerance ± 0.05
lead finish Au 

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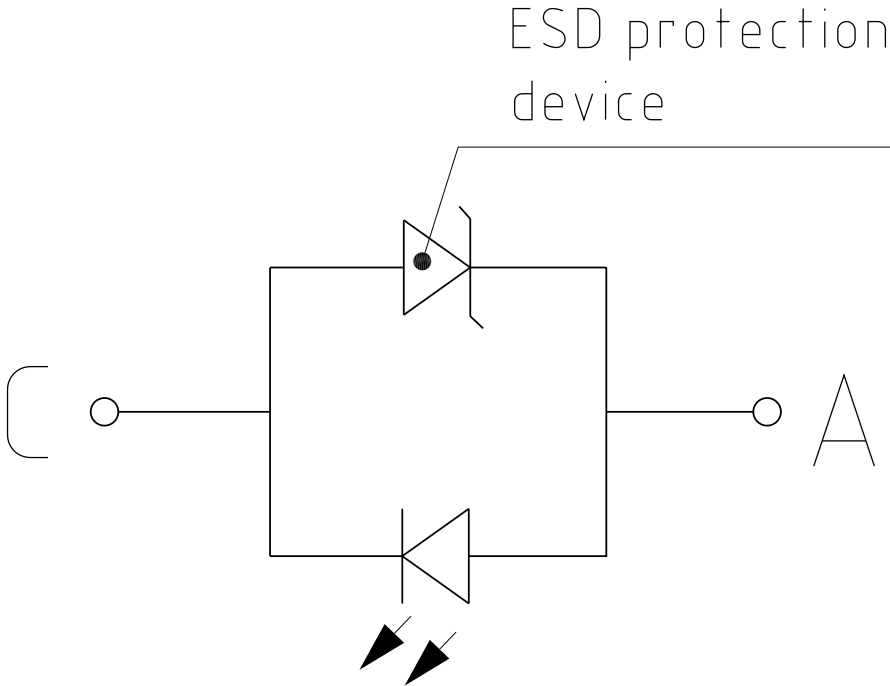
Further Information:

Approximate Weight: 7.8 mg

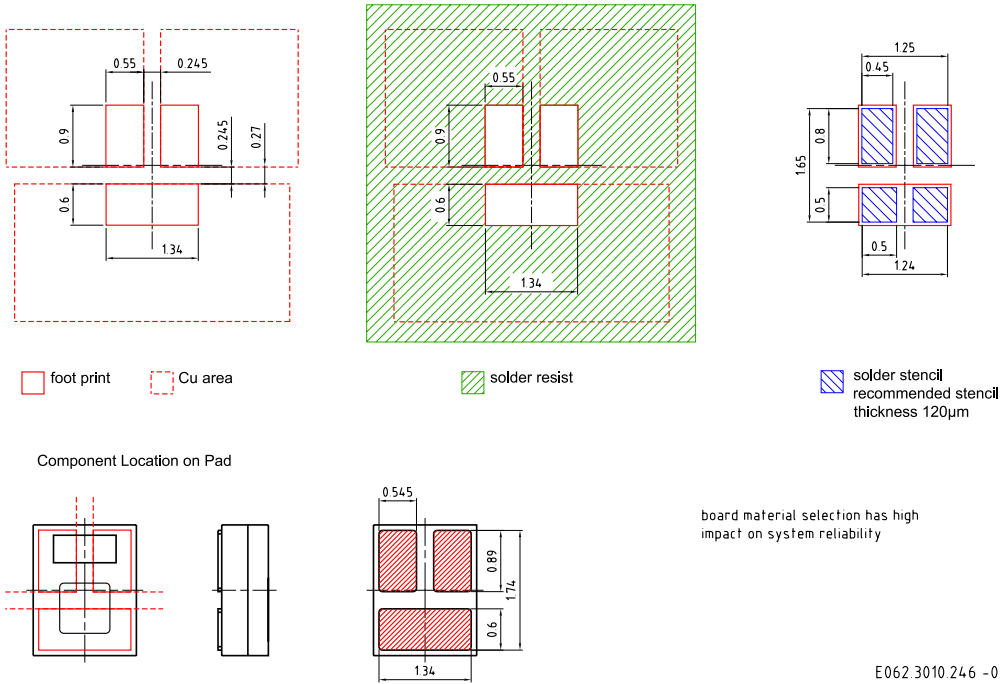
Corrosion test: Class: 3A
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Electrical Internal Circuit



Recommended Solder Pad ⁹⁾

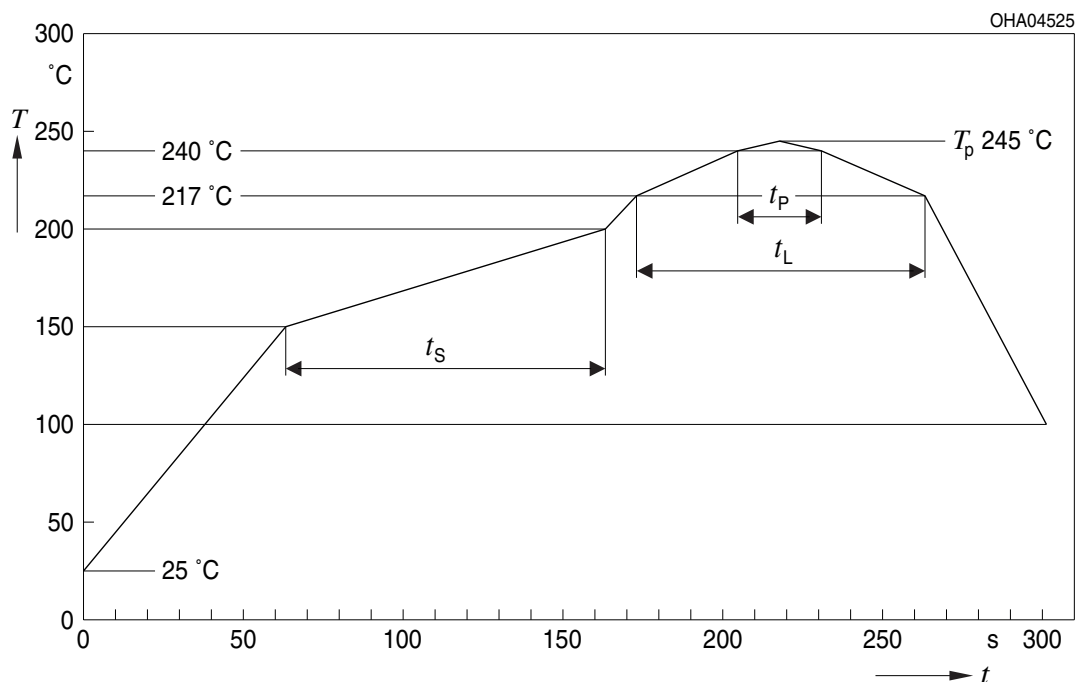


E062.3010.246 -02

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.

Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E

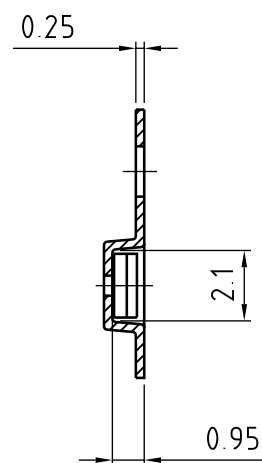
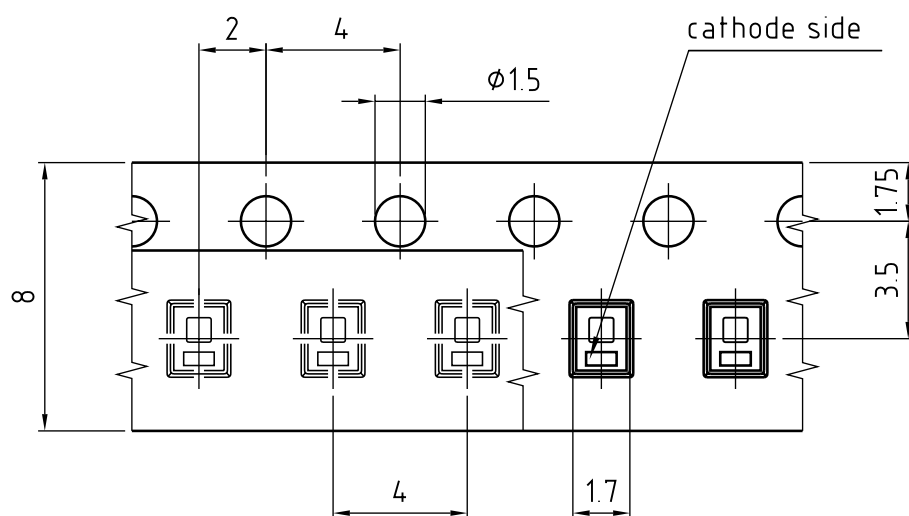


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		$^{\circ}\text{C}$
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	$^{\circ}\text{C}$
Time within 5 °C of the specified peak temperature $T_p - 5\text{ K}$	t_p	10	20	30	s
Ramp-down rate*) T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

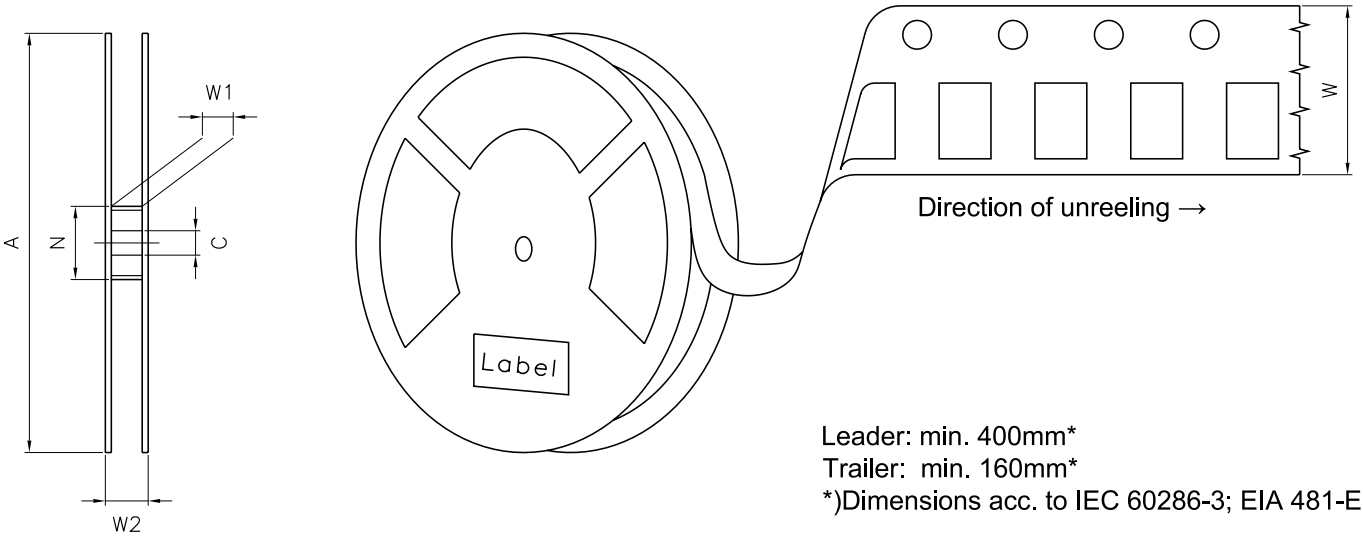
*) slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁹⁾



C63062-A4372-B7-02

Tape and Reel ¹⁰⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	4000

OSRAM

BIN1: XX-XX-X-XXX-X

(6P) BATCH NO: 1234567890



(1T) LOT NO: 1234567890

(9D) D/C: 1234



ML Temp ST
X XXX °C X



Pack: RXX

DEMY XXX

X X123 1234.1234 X

(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X



OHA04563

The diagram illustrates the components of a moisture-sensitive product packaging. It shows two main items: a rectangular package and a circular component, both with labels and desiccant indicators.

- Moisture-sensitive label or print:** A label on the rectangular package.
- Barcode label:** A label on the rectangular package.
- Humidity indicator:** A small, rectangular component on the circular component.
- Barcode label:** A label on the circular component.
- Desiccant:** Two small, rectangular components, one on the rectangular package and one on the circular component.

QHA00530

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Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers avoid device exposure to aggressive substances during storage, production, and use.

For further application related information please visit <https://ams-osram.com/support/application-notes>

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 1 ms, with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (acc. to GUM with a coverage factor of $k = 3$).
- 2) **Operating Temperature:** The Operating Temperature T_{op} is referenced to the Solderpoint T_s of this device. Proper current derating must be observed to maintain junction temperature below the maximum.
- 3) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 4) **Chromaticity coordinate groups:** Chromaticity coordinates are measured during a current pulse of typically 1 ms, with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (acc. to GUM with a coverage factor of $k = 3$).
- 5) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 1 ms, with an internal reproducibility of $\pm 0.05\text{ V}$ and an expanded uncertainty of $\pm 0.1\text{ V}$ (acc. to GUM with a coverage factor of $k = 3$).
- 6) **Thermal Resistance:** $R_{th\text{ max}}$ is based on statistic values (6σ) used for Derating.
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2023-09-28	Initial Version
1.1	2024-06-14	Features



EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，
不含有毒有害物质或元素。

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Tobelbader Strasse 30, 8141 Premstaetten, Austria

Phone +43 3136 500-0

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